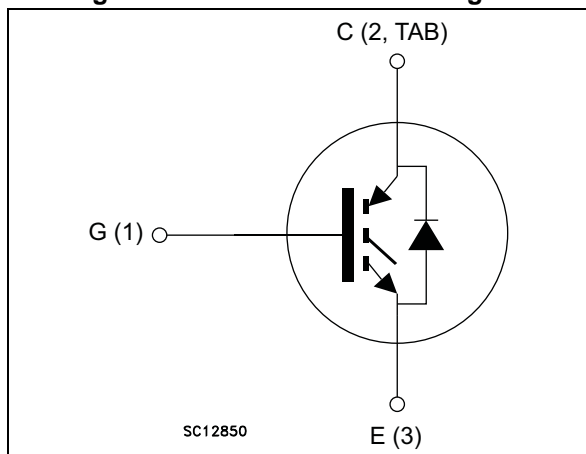


Figure 1. Internal schematic diagram



### Features

- Maximum junction temperature:  $T_J = 175\text{ °C}$
- Tail-less switching off
- $V_{CE(sat)} = 1.8\text{ V (typ.) @ } I_C = 40\text{ A}$
- Tight parameters distribution
- Safe paralleling
- Low thermal resistance
- Very fast soft recovery antiparallel diode

### Applications

- Photovoltaic inverters
- Uninterruptible power supply
- Welding
- Power factor correction
- Very high frequency converters

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the V series of IGBTs, which represent an optimum compromise between conduction and switching losses to maximize the efficiency of very high frequency converters. Furthermore, a positive  $V_{CE(sat)}$  temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGFW40V60DF	GFW40V60DF	TO-3PF	Tube
STGW40V60DF	GW40V60DF	TO-247	Tube
STGWT40V60DF	GWT40V60DF	TO-3P	Tube

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- 2      Electrical characteristics ..... 4**
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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value		Unit
		TO-247 TO-3P	TO-3PF	
$V_{CES}$	Collector-emitter voltage ( $V_{GE} = 0$ )	600		V
$I_C$	Continuous collector current at $T_C = 25\text{ °C}$	80		A
$I_C$	Continuous collector current at $T_C = 100\text{ °C}$	40		A
$I_{CP}^{(1)}$	Pulsed collector current	160		A
$V_{GE}$	Gate-emitter voltage	±20		V
$I_F$	Continuous forward current at $T_C = 25\text{ °C}$	80		A
$I_F$	Continuous forward current at $T_C = 100\text{ °C}$	40		A
$I_{FP}^{(1)}$	Pulsed forward current	160		A
$P_{TOT}$	Total dissipation at $T_C = 25\text{ °C}$	283	62.5	W
$V_{ISO}$	Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t = 1\text{ s}$ ; $T_c = 25\text{ °C}$ )		3.5	kV
$T_{STG}$	Storage temperature range	- 55 to 150		°C
$T_J$	Operating junction temperature	- 55 to 175		°C

1. Pulse width limited by maximum junction temperature

**Table 3. Thermal data**

Symbol	Parameter	Value		Unit
		TO-247 TO-3P	TO-3PF	
$R_{thJC}$	Thermal resistance junction-case IGBT	0.53	2.4	°C/W
$R_{thJC}$	Thermal resistance junction-case diode	1.14		°C/W
$R_{thJA}$	Thermal resistance junction-ambient	50		°C/W

## 2 Electrical characteristics

$T_J = 25\text{ °C}$  unless otherwise specified.

**Table 4. Static characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ( $V_{GE} = 0$ )	$I_C = 2\text{ mA}$	600			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 40\text{ A}$		1.8	2.3	V
		$V_{GE} = 15\text{ V}, I_C = 40\text{ A}$ $T_J = 125\text{ °C}$		2.15		
		$V_{GE} = 15\text{ V}, I_C = 40\text{ A}$ $T_J = 175\text{ °C}$		2.35		
$V_F$	Forward on-voltage	$I_F = 40\text{ A}$		1.7	2.45	V
		$I_F = 40\text{ A}, T_J = 125\text{ °C}$		1.4		V
		$I_F = 40\text{ A}, T_J = 175\text{ °C}$		1.3		V
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1\text{ mA}$	5	6	7	V
$I_{CES}$	Collector cut-off current ( $V_{GE} = 0$ )	$V_{CE} = 600\text{ V}$			25	$\mu\text{A}$
$I_{GES}$	Gate-emitter leakage current ( $V_{CE} = 0$ )	$V_{GE} = \pm 20\text{ V}$			250	nA

**Table 5. Dynamic characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{ies}$	Input capacitance	$V_{CE} = 25\text{ V}, f = 1\text{ MHz},$ $V_{GE} = 0$	-	5400	-	pF
$C_{oes}$	Output capacitance		-	220	-	pF
$C_{res}$	Reverse transfer capacitance		-	180	-	pF
$Q_g$	Total gate charge	$V_{CC} = 480\text{ V}, I_C = 40\text{ A},$ $V_{GE} = 15\text{ V},$ see <a href="#">Figure 34</a>	-	226	-	nC
$Q_{ge}$	Gate-emitter charge		-	38	-	nC
$Q_{gc}$	Gate-collector charge		-	95	-	nC

**Table 6. IGBT switching characteristics (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 400\text{ V}$ , $I_C = 40\text{ A}$ , $R_G = 10\ \Omega$ , $V_{GE} = 15\text{ V}$ , see <a href="#">Figure 33</a>	-	52	-	ns
$t_r$	Current rise time		-	17	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1850	-	A/ $\mu$ s
$t_{d(off)}$	Turn-off delay time		-	208	-	ns
$t_f$	Current fall time		-	20	-	ns
$E_{on}^{(1)}$	Turn-on switching losses		-	456	-	$\mu$ J
$E_{off}^{(2)}$	Turn-off switching losses		-	411	-	$\mu$ J
$E_{ts}$	Total switching losses	-	867	-	$\mu$ J	
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 400\text{ V}$ , $I_C = 40\text{ A}$ , $R_G = 10\ \Omega$ , $V_{GE} = 15\text{ V}$ , $T_J = 175\text{ }^\circ\text{C}$ , see <a href="#">Figure 33</a>	-	52	-	ns
$t_r$	Current rise time		-	21	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1538	-	A/ $\mu$ s
$t_{d(off)}$	Turn-off delay time		-	220	-	ns
$t_f$	Current fall time		-	21	-	ns
$E_{on}^{(1)}$	Turn-on switching losses		-	1330	-	$\mu$ J
$E_{off}^{(2)}$	Turn-off switching losses		-	560	-	$\mu$ J
$E_{ts}$	Total switching losses	-	1890	-	$\mu$ J	

1. Energy losses include reverse recovery of the diode.
2. Turn-off losses include also the tail of the collector current.

**Table 7. Diode switching characteristics (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{rr}$	Reverse recovery time	$I_F = 40\text{ A}$ , $V_R = 400\text{ V}$ , $V_{GE} = 15\text{ V}$ , $di/dt=1000\text{ A}/\mu\text{s}$ see <a href="#">Figure 33</a>	-	41	-	ns
$Q_{rr}$	Reverse recovery charge		-	440	-	nC
$I_{rrm}$	Reverse recovery current		-	21.6	-	A
$dl_{rr}/dt$	Peak rate of fall of reverse recovery current during $t_b$		-	1363	-	A/ $\mu$ s
$E_{rr}$	Reverse recovery energy		-	151	-	$\mu$ J
$t_{rr}$	Reverse recovery time	$I_F = 40\text{ A}$ , $V_R = 400\text{ V}$ , $V_{GE} = 15\text{ V}$ , $di/dt=1000\text{ A}/\mu\text{s}$ $T_J = 175\text{ }^\circ\text{C}$ , see <a href="#">Figure 33</a>	-	109	-	ns
$Q_{rr}$	Reverse recovery charge		-	2400	-	nC
$I_{rrm}$	Reverse recovery current		-	44.4	-	A
$dl_{rr}/dt$	Peak rate of fall of reverse recovery current during $t_b$		-	670	-	A/ $\mu$ s
$E_{rr}$	Reverse recovery energy		-	718	-	$\mu$ J

## 2.1 Electrical characteristics (curves)

Figure 2. Power dissipation vs. case temperature for TO-247 and TO-3P

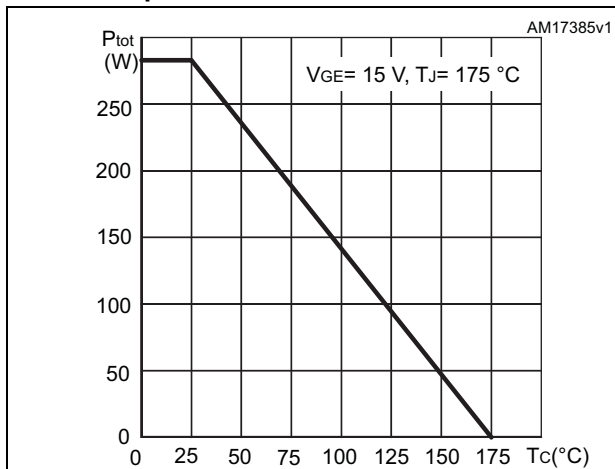


Figure 3. Collector current vs. case temperature for TO-247 and TO-3P

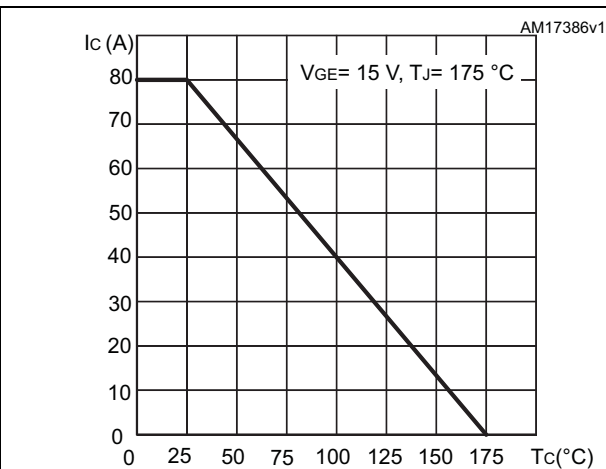


Figure 4. Power dissipation vs. case temperature for TO-3PF

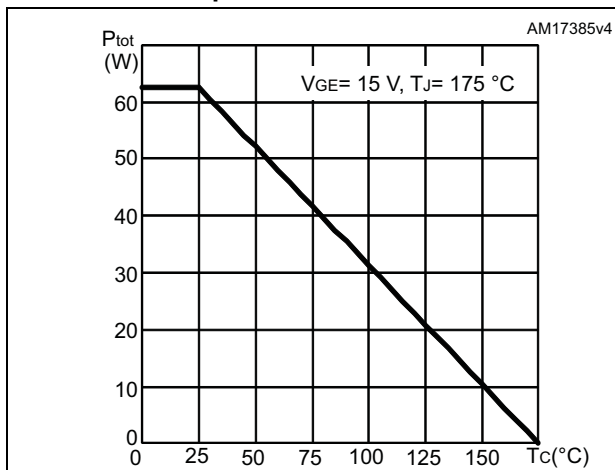


Figure 5. Collector current vs. case temperature for TO-3PF

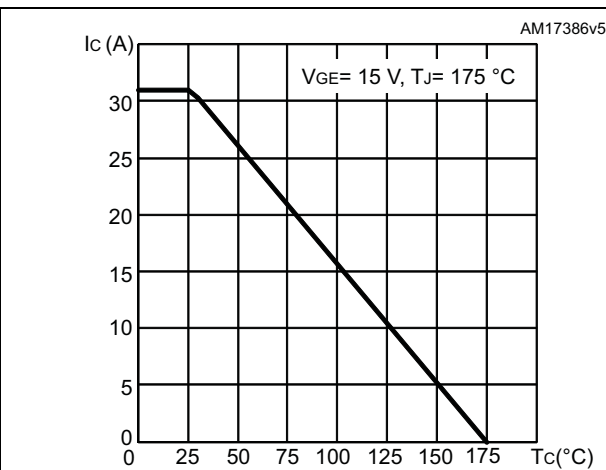


Figure 6. Output characteristics (Tj=25°C)

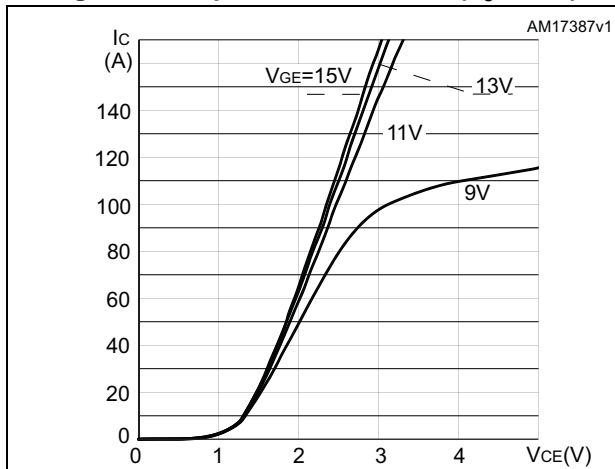


Figure 7. Output characteristics (Tj=175°C)

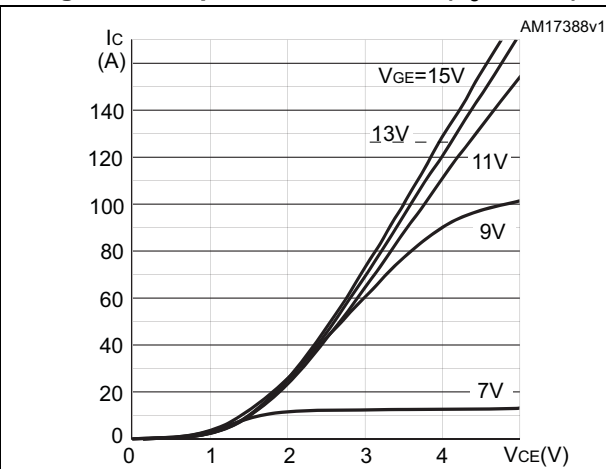


Figure 8.  $V_{CE(sat)}$  vs. junction temperature

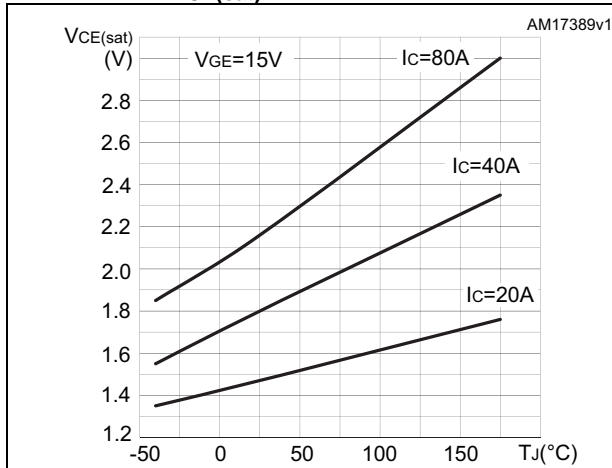


Figure 9.  $V_{CE(sat)}$  vs. collector current

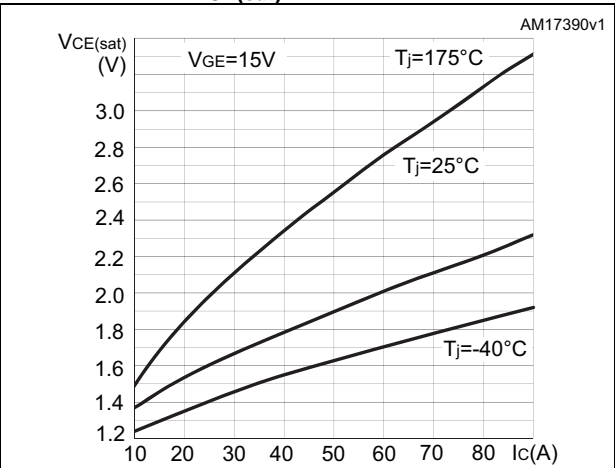


Figure 10. Collector current vs. switching frequency for TO-247 and TO-3P

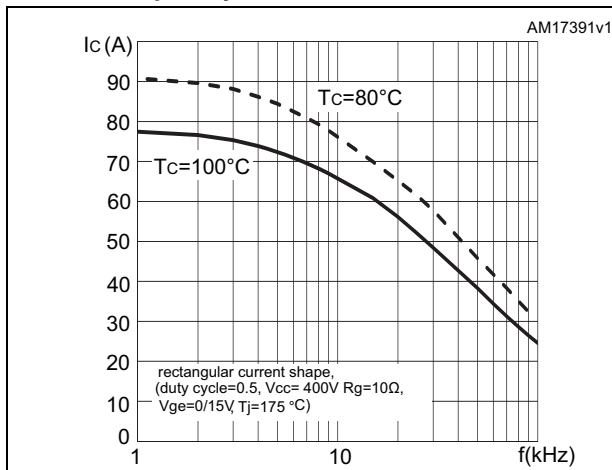


Figure 11. Collector current vs. switching frequency for TO-3PF

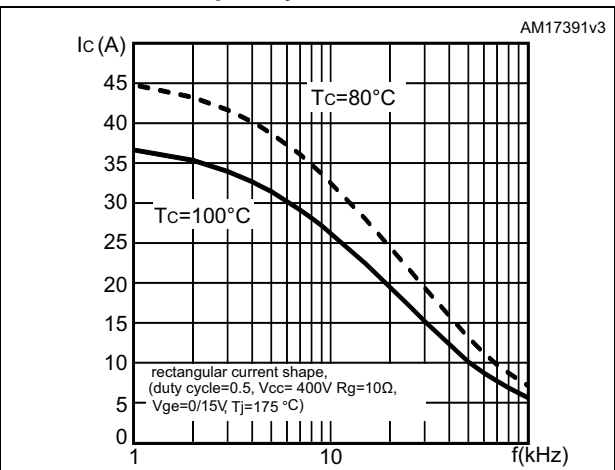


Figure 12. Forward bias safe operating area for TO-247 and TO-3P

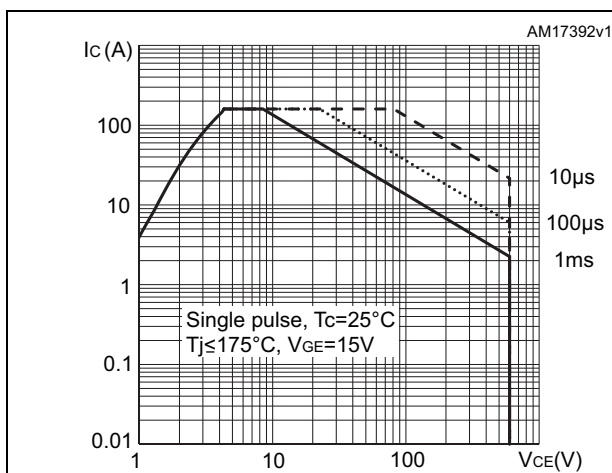


Figure 13. Forward bias safe operating area for TO-3PF

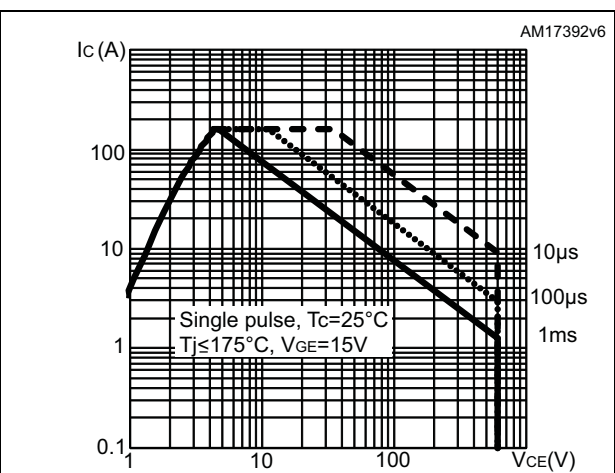


Figure 14. Transfer characteristics

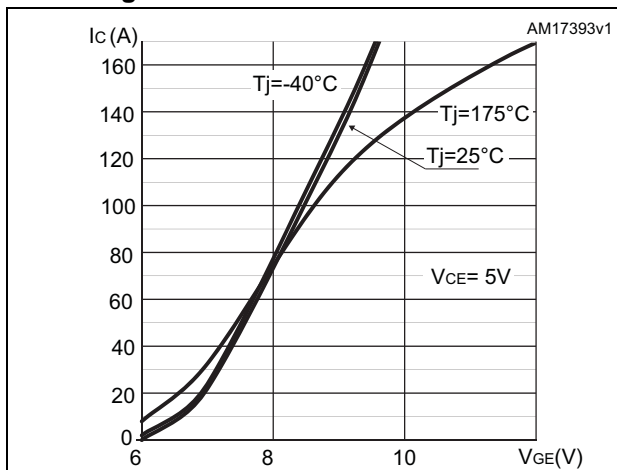


Figure 15. Diode  $V_F$  vs. forward current

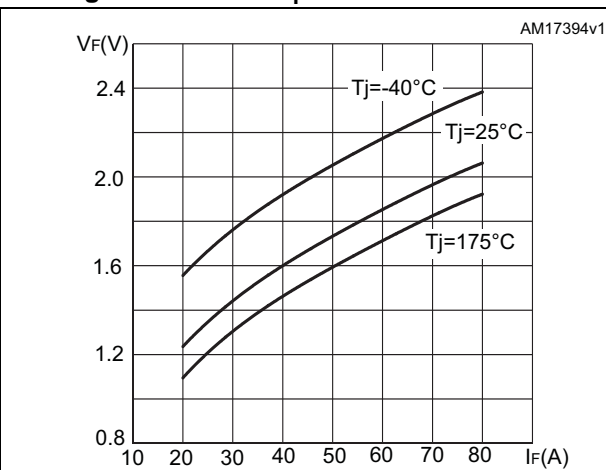


Figure 16. Normalized  $V_{GE(th)}$  vs junction temperature

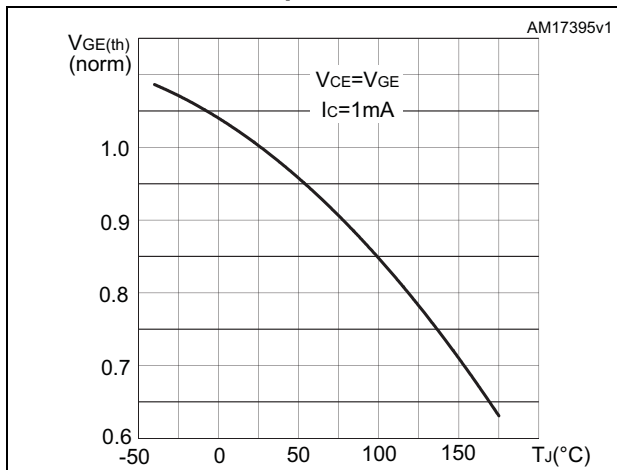


Figure 17. Normalized  $V_{(BR)CES}$  vs. junction temperature

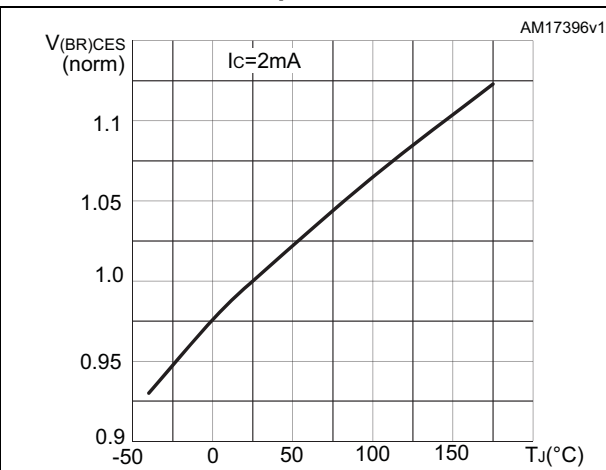


Figure 18. Capacitance variations

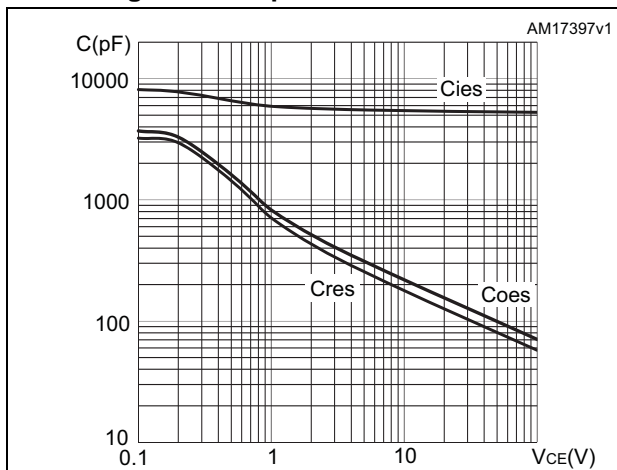


Figure 19. Gate charge vs. gate-emitter voltage

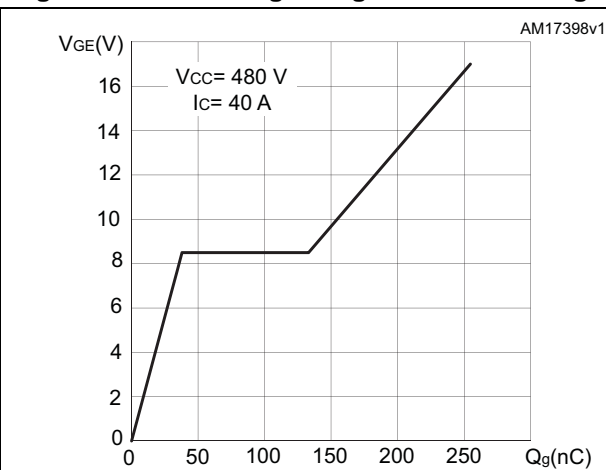




Figure 20. Switching losses vs. collector current

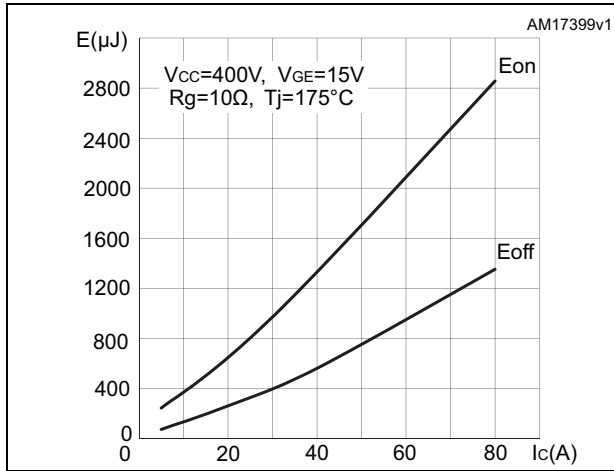


Figure 21. Switching losses vs. gate resistance

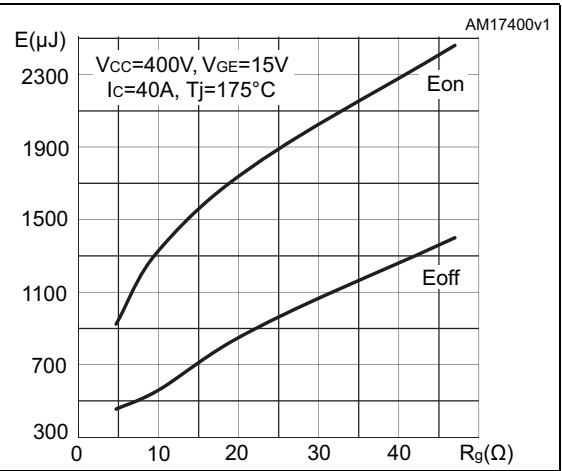


Figure 22. Switching losses vs. junction temperature

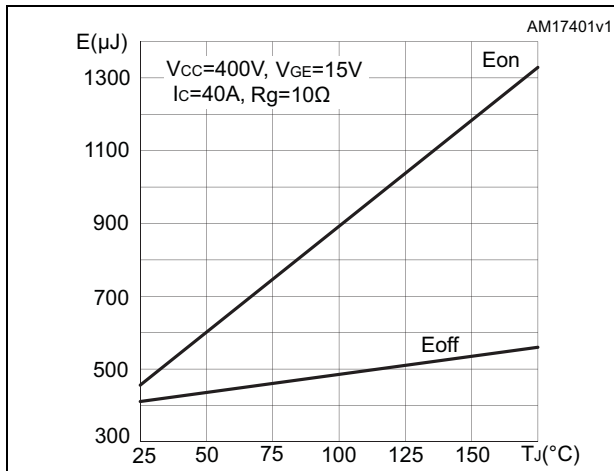


Figure 23. Switching losses vs. collector emitter voltage

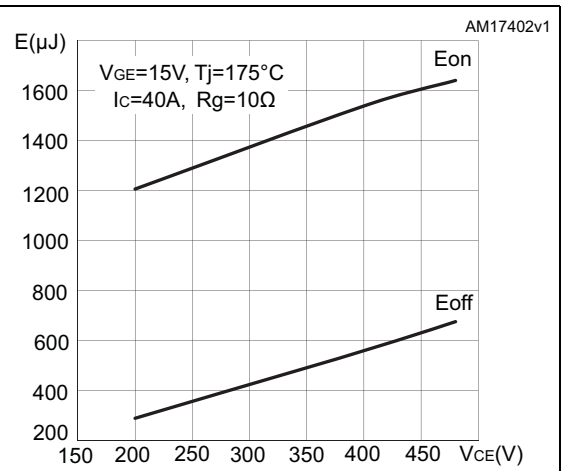


Figure 24. Switching times vs. collector current

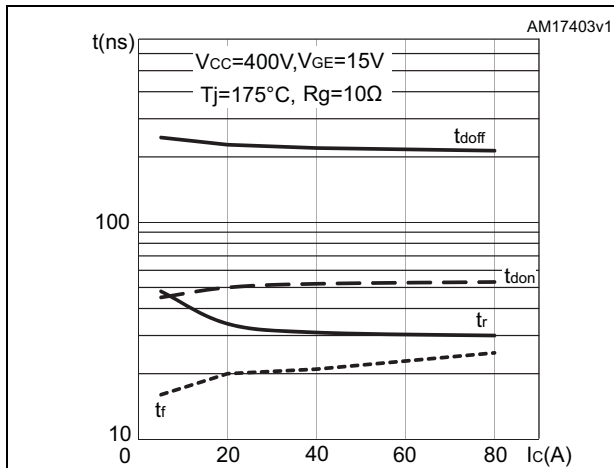


Figure 25. Switching times vs. gate resistance

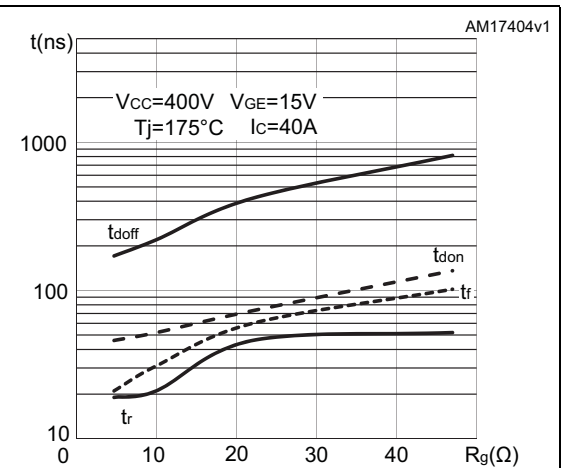


Figure 26. Reverse recovery current vs. diode current slope

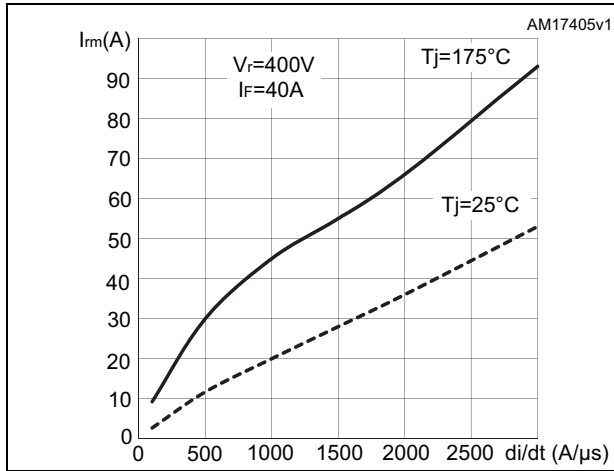


Figure 27. Reverse recovery time vs. diode current slope

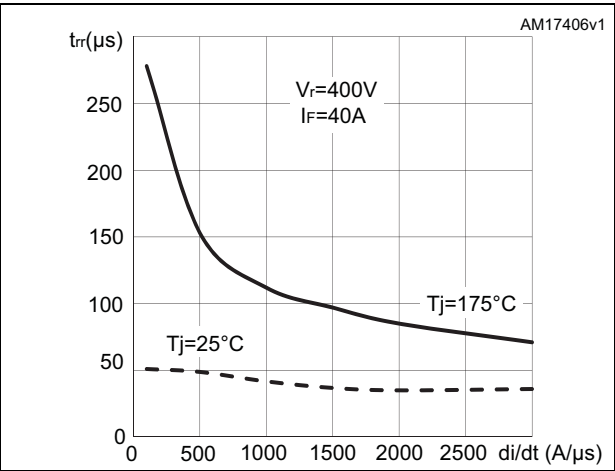


Figure 28. Reverse recovery charge vs. diode current slope

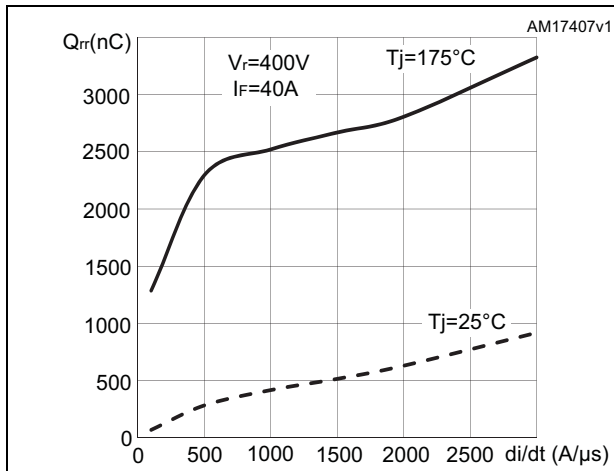


Figure 29. Reverse recovery energy vs. diode current slope

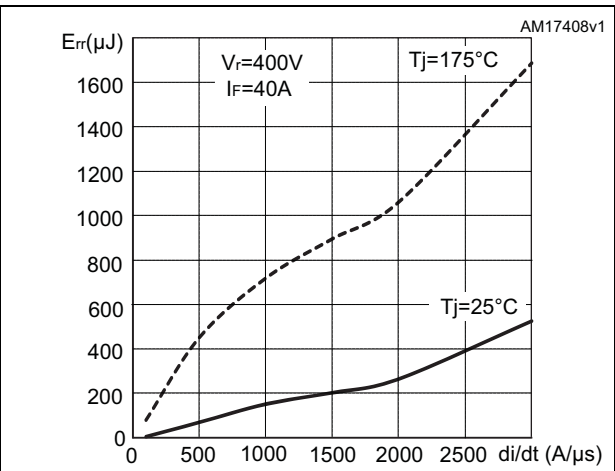


Figure 30. Thermal data for IGBT in TO-247 and TO-3P

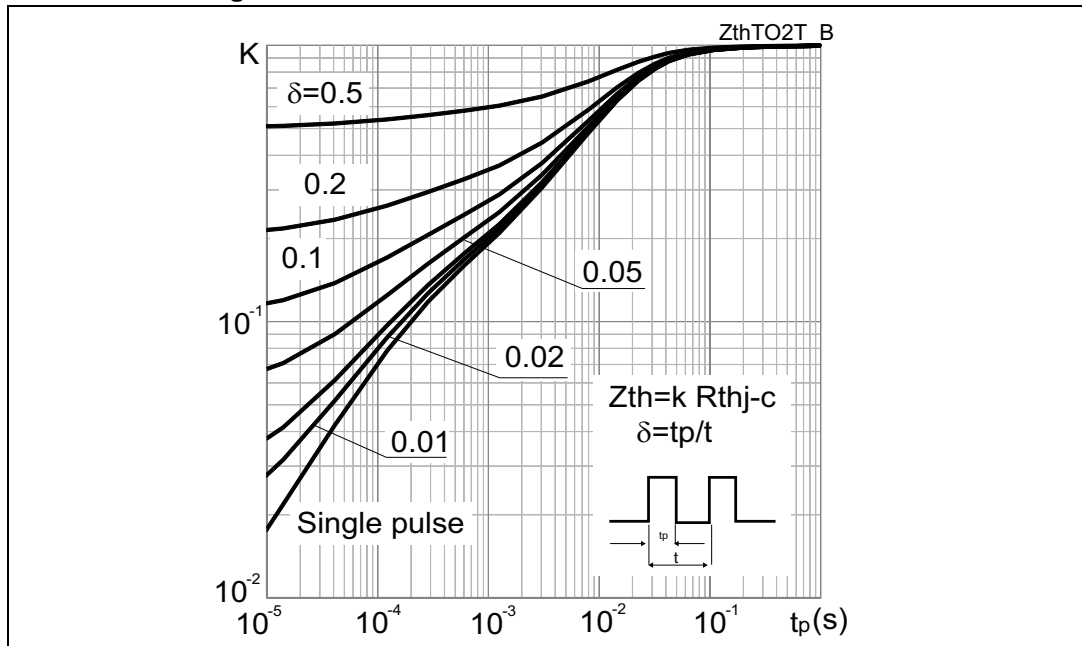


Figure 31. Thermal data for IGBT in TO-3PF

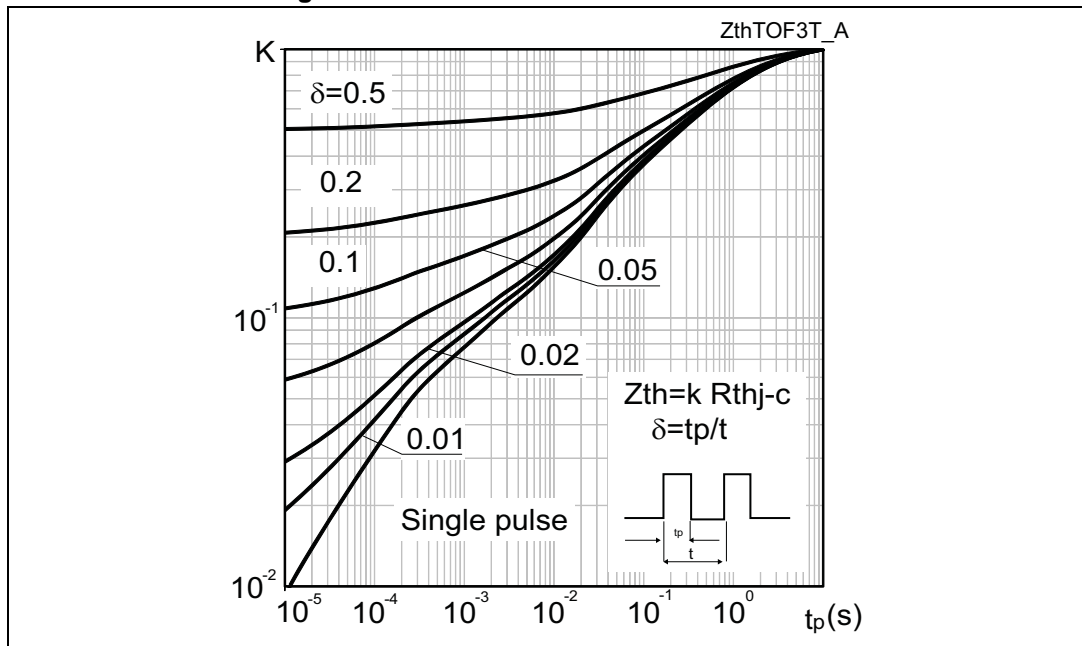
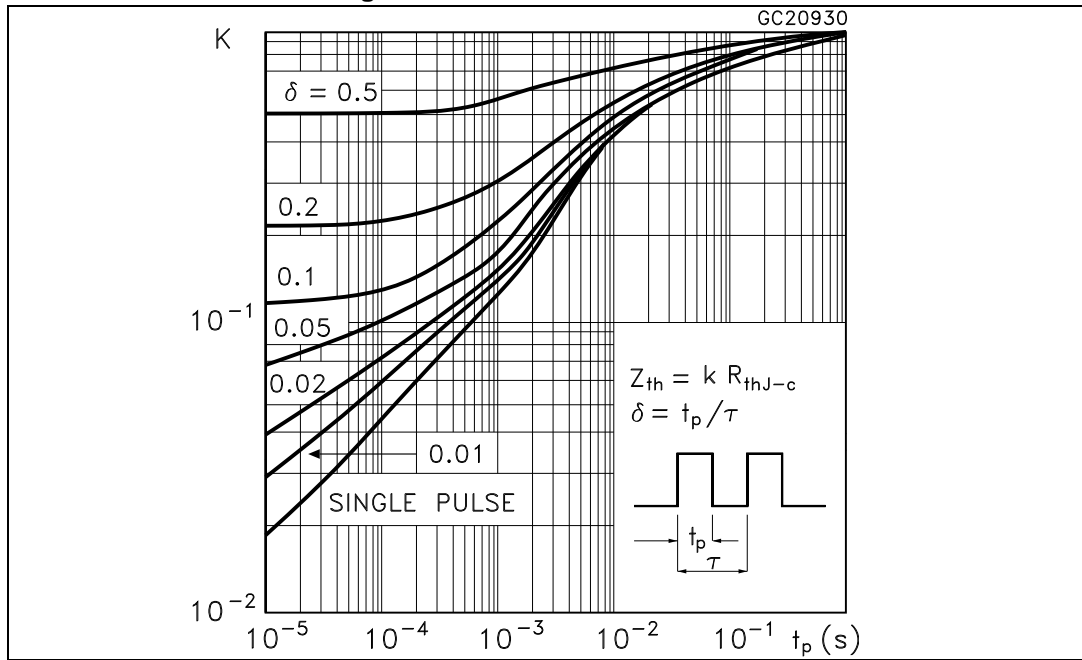


Figure 32. Thermal data for diode



### 3 Test circuits

Figure 33. Test circuit for inductive load switching

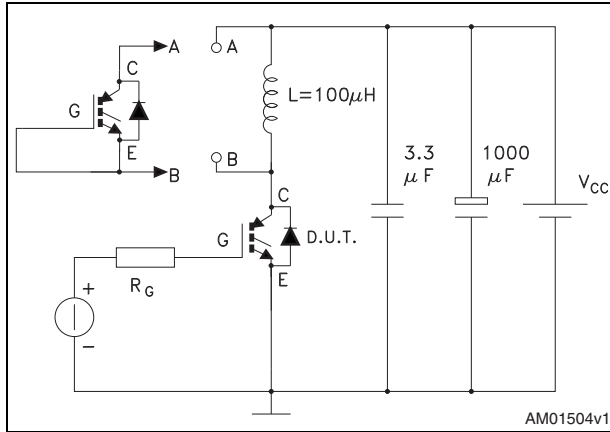


Figure 34. Gate charge test circuit

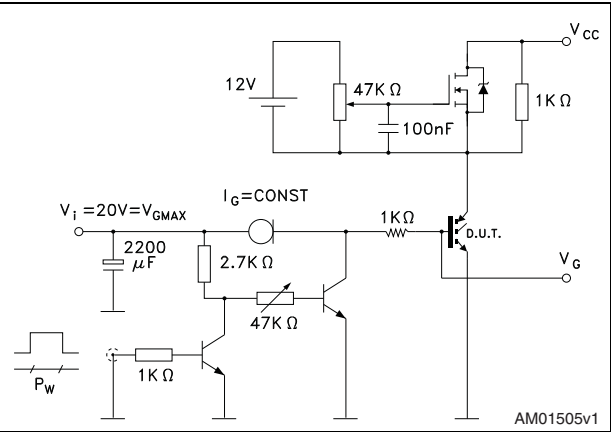


Figure 35. Switching waveform

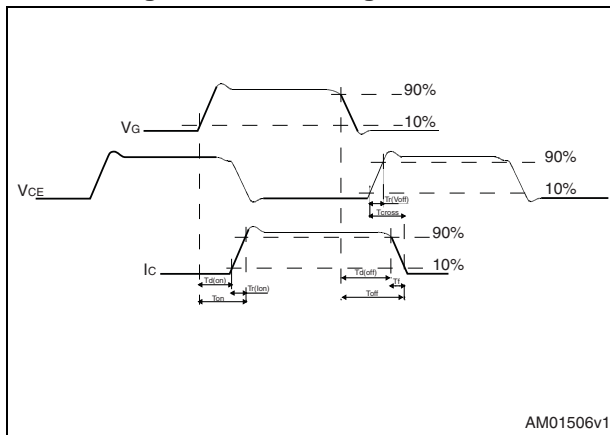
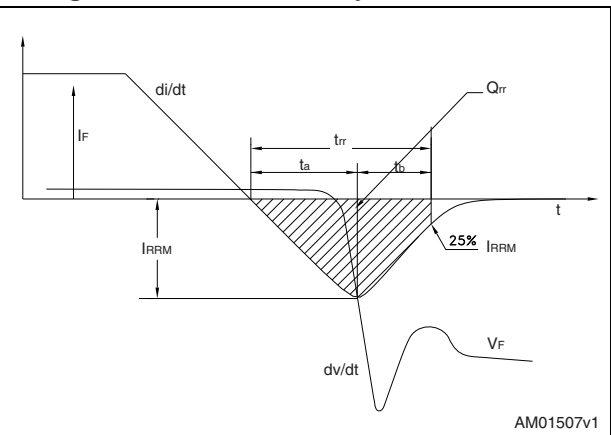


Figure 36. Diode recovery time waveform



## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-3PF, STGFW40V60DF

Figure 37. TO-3PF drawing

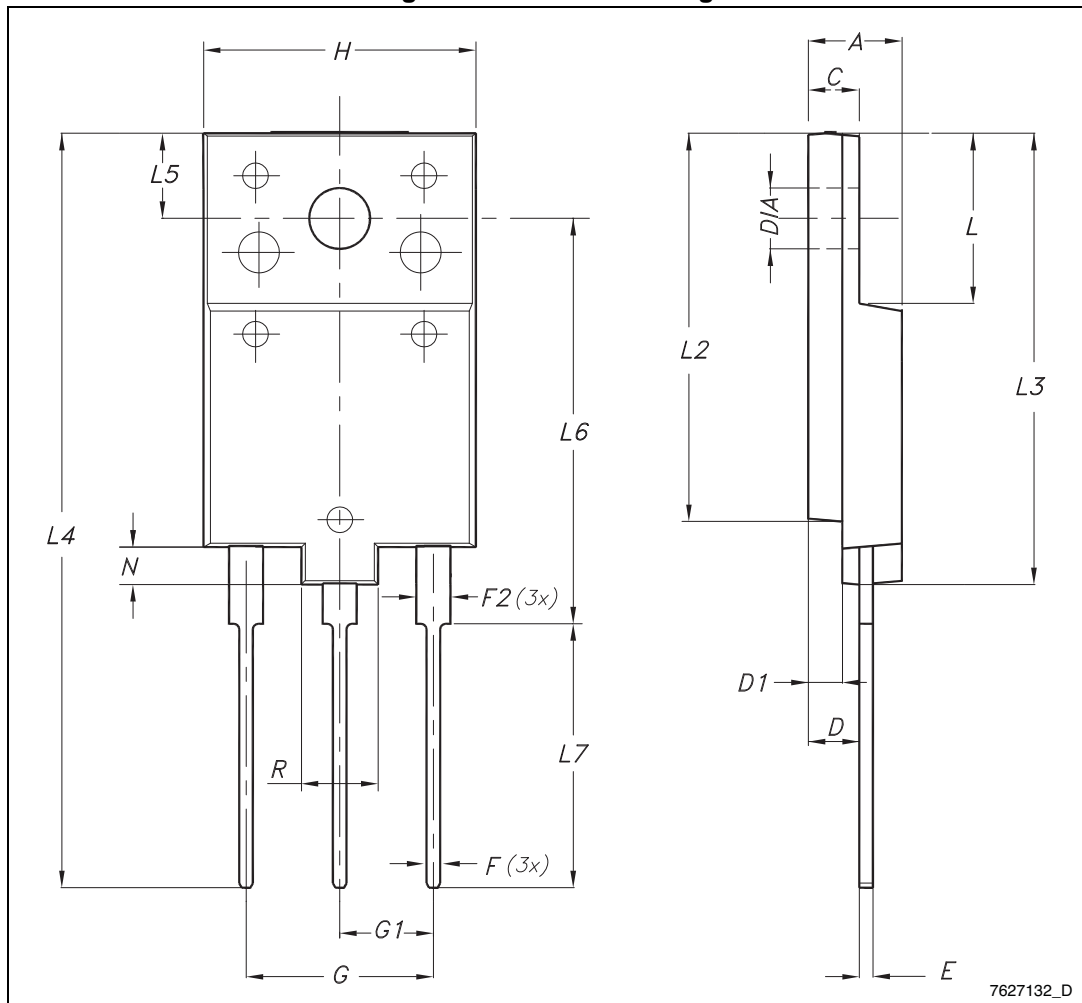


Table 8. TO-3PF mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	5.30		5.70
C	2.80		3.20
D	3.10		3.50
D1	1.80		2.20
E	0.80		1.10
F	0.65		0.95
F2	1.80		2.20
G	10.30		11.50
G1		5.45	
H	15.30		15.70
L	9.80	10	10.20
L2	22.80		23.20
L3	26.30		26.70
L4	43.20		44.40
L5	4.30		4.70
L6	24.30		24.70
L7	14.60		15
N	1.80		2.20
R	3.80		4.20
Dia	3.40		3.80

### 4.2 TO-247, STGW40V60DF

Figure 38. TO-247 drawing

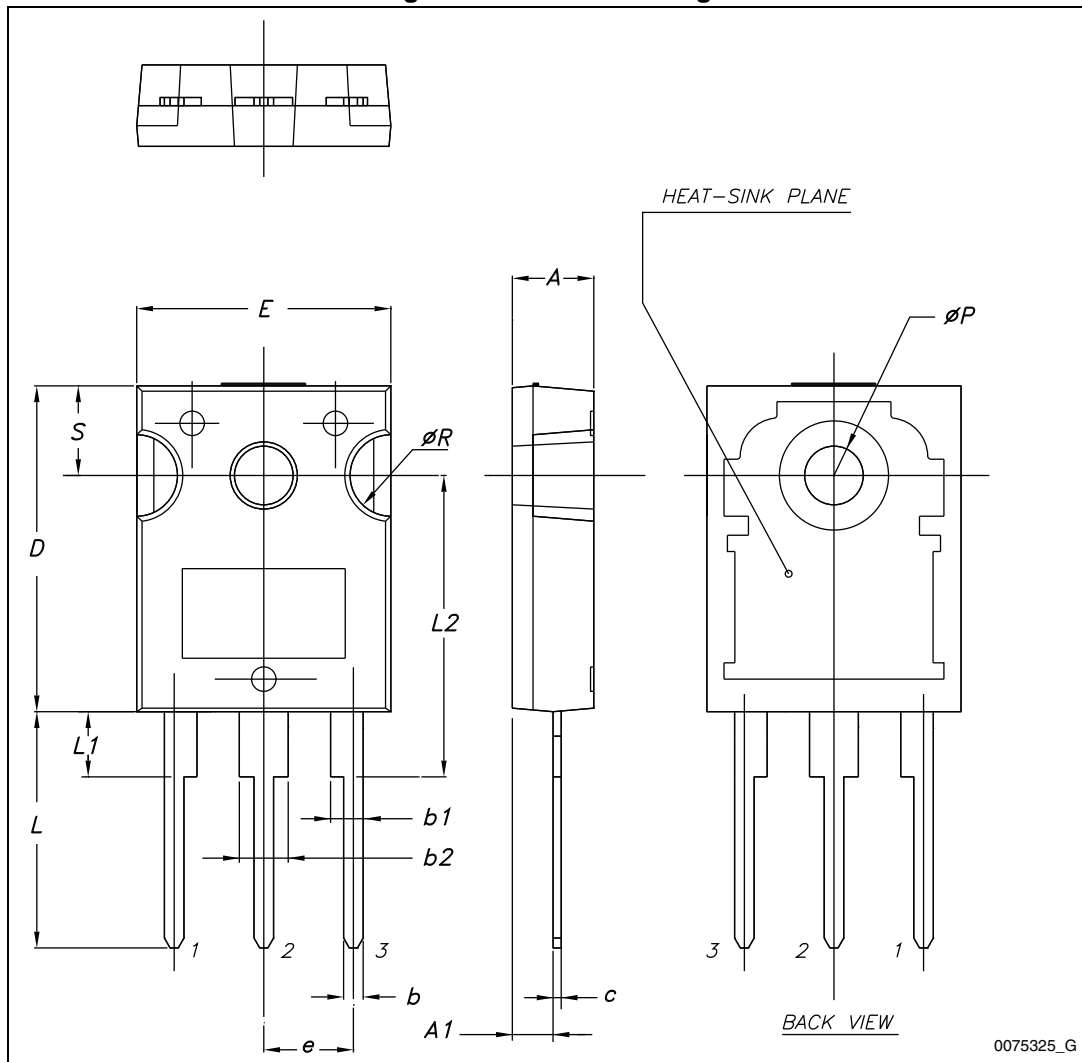


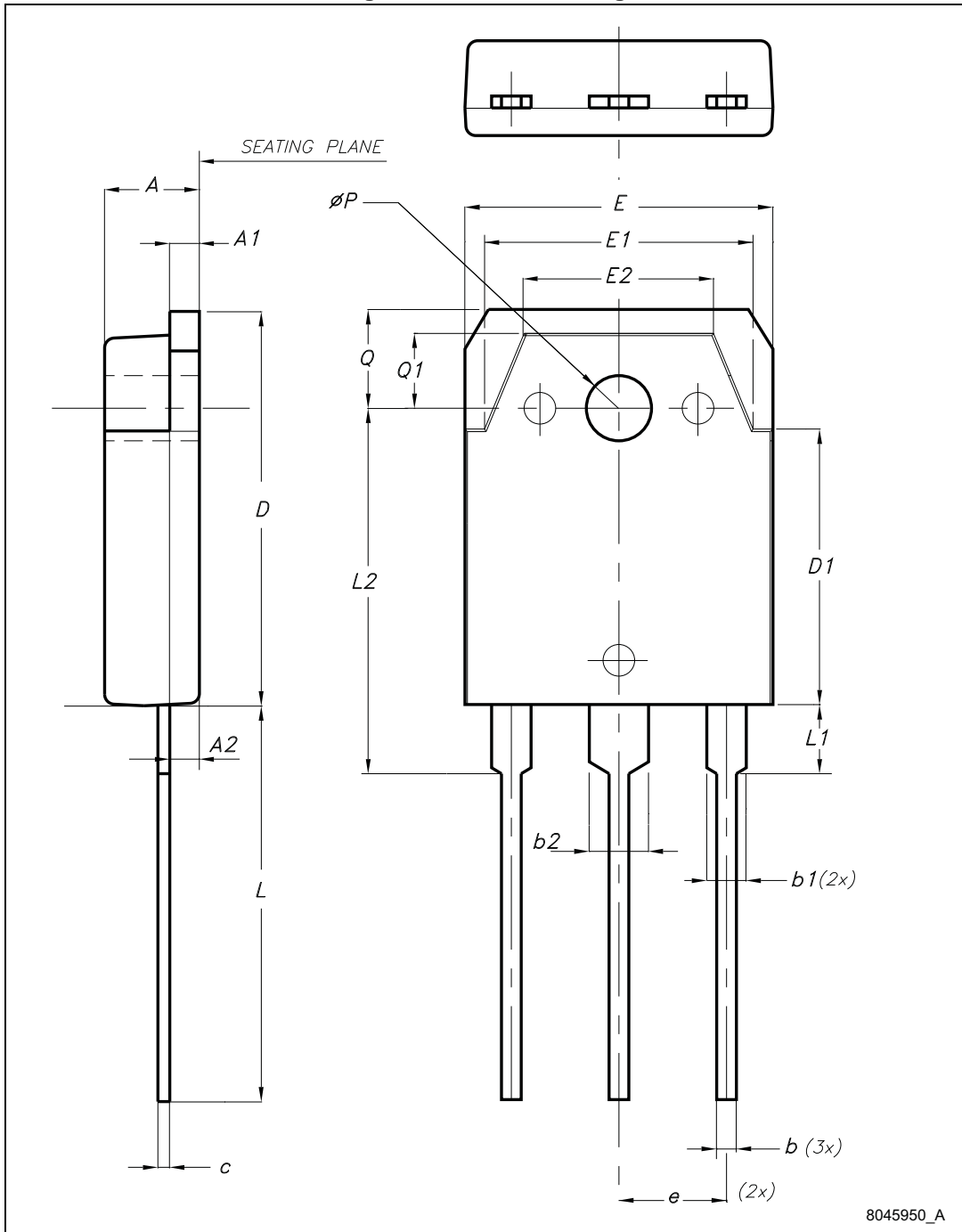


Table 9. TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

### 4.3 TO-3P, STGWT40V60DF

Figure 39. TO-3P drawing



8045950\_A

Table 10. TO-3P mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.60		5
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1	1.20
b1	1.80		2.20
b2	2.80		3.20
c	0.55	0.60	0.75
D	19.70	19.90	20.10
D1		13.90	
E	15.40		15.80
E1		13.60	
E2		9.60	
e	5.15	5.45	5.75
L	19.50	20	20.50
L1		3.50	
L2	18.20	18.40	18.60
øP	3.10		3.30
Q		5	
Q1		3.80	